1. General description

High voltage, high speed, planar passivated NPN power switching transistor with integrated antiparallel E-C diode in a SOT428 (DPAK) surface mountable plastic package.

2. Features and benefits

- Fast switching
- · High voltage capability
- · Integrated anti-parallel E-C diode
- Surface mountable plastic package
- · Very low switching and conduction losses

3. Applications

- DC-to-DC converters
- · Electronic lighting ballasts
- Inverters
- Motor control systems

4. Pinning information

Table 1. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base		C
2	С	collector[1]		
3	Е	emitter	DPAK (SOT428)	B E E sym131

[1] It is not possible to make a connection to pin 2 of the SOT428 (DPAK) package.

NPN power transistor with integrated diode

5. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
BUJD105AD	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	SOT428		

NPN power transistor with integrated diode

6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CESM}	collector-emitter peak voltage	V _{BE} = 0 V	-	700	V
V_{CBO}	collector-base voltage	I _E = 0 A	-	700	V
V_{CEO}	collector-emitter voltage	I _B = 0 A	-	400	V
I _C	collector current	DC; Fig. 1; Fig. 2	-	8	Α
I _{CM}	peak collector current	Fig. 1; Fig. 2	-	16	Α
I _B	base current	DC	-	4	Α
I _{BM}	peak base current		-	8	Α
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C; <u>Fig. 3</u>	-	80	W
T _{stg}	storage temperature		-65	150	°C
Tj	junction temperature		-	150	°C

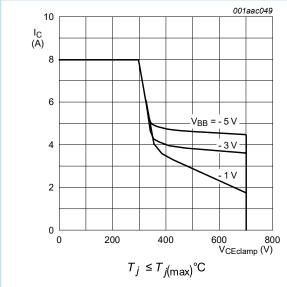


Fig. 1. Reverse bias safe operating area

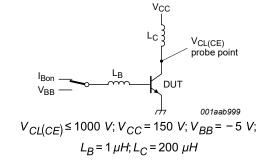


Fig. 2. Test circuit for reverse bias safe operating area

NPN power transistor with integrated diode

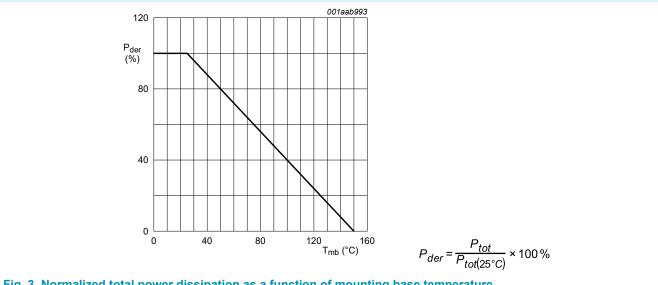


Fig. 3. Normalized total power dissipation as a function of mounting base temperature

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7. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 4	-	-	1.56	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	printed circuit board (FR4) mounted; minimum footprint; Fig. 5	-	75	-	K/W

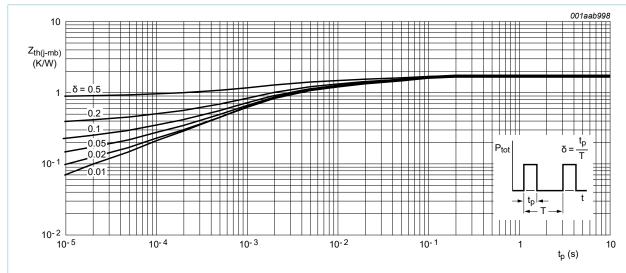


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse width

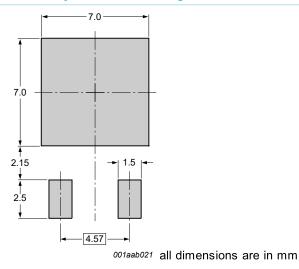


Fig. 5. Minimum footprint SOT428

NPN power transistor with integrated diode

8. Characteristics

Table 5. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static chara	cteristics						
I _{CES}	collector-emitter cut-off	V _{BE} = 0 V; V _{CE} = 700 V; T _j = 25 °C	[1]	-	-	0.2	mA
	current (base shorted)	V _{BE} = 0 V; V _{CE} = 700 V; T _j = 125 °C	[1]	-	-	0.5	mA
I _{CBO}	collector-base cut-off current (emitter open)	$V_{CB} = 700 \text{ V}; I_{E} = 0 \text{ A}$	[1]	-	-	0.2	mA
СЕО	collector-emitter cut-off current (base open)	$V_{CE} = 400 \text{ V}; I_{B} = 0 \text{ A}$	[1]	-	-	0.1	mA
I _{EBO}	emitter-base cut-off current (collector open)	$V_{EB} = 9 \text{ V}; I_{C} = 0 \text{ A}$		-	-	10	mA
V _{CEsat}	collector-emitter saturation voltage	I _C = 4 A; I _B = 0.8 A; <u>Fig. 6</u> ; <u>Fig. 7</u>		-	0.35	1	V
V_{BEsat}	base-emitter saturation voltage	I _C = 4 A; I _B = 0.8 A; <u>Fig. 8</u>		-	1	1.5	V
V _F	forward voltage	I _F = 4 A; T _j = 25 °C		-	1.07	1.5	V
h _{FE}	DC current gain	I _C = 4 A; V _{CE} = 5 V; T _{mb} = 25 °C; <u>Fig. 9</u> ; <u>Fig. 10</u>		8	12.5	-	
		I _C = 1 mA; V _{CE} = 5 V; T _{mb} = 25 °C		10	17	34	
		I _C = 500 mA; V _{CE} = 5 V; T _{mb} = 25 °C		13	22	36	
Dynamic ch	aracteristics						
t _{on}	turn-on time	I _C = 5 A; I _{Bon} = 1 A; I _{Boff} = -1 A;		-	0.65	1	μs
t _s	storage time	$R_L = 75 \Omega$; $T_j = 25 °C$; resistive load; Fig. 11; Fig. 12		-	1.8	2.5	μs
		I_C = 5 A; I_{Bon} = 1 A; V_{BB} = -5 V; L_B = 1 μ H; T_j = 25 °C; inductive load; <u>Fig. 13</u> ; <u>Fig. 14</u>		-	1.2	1.7	μs
		I_C = 5 A; I_{Bon} = 1 A; V_{BB} = -5 V; L_B = 1 μ H; T_j = 100 °C; inductive load; Fig. 13; Fig. 14		-	1.4	1.9	μs
t _f	fall time	I_C = 5 A; I_{Bon} = 1 A; V_{BB} = -5 V; L_B = 1 μ H; T_{mb} = 25 °C; inductive load; Fig. 13; Fig. 14		-	0.02	0.05	μs
		I_C = 5 A; I_{Bon} = 1 A; V_{BB} = -5 V; L_B = 1 μ H; T_{mb} = 100 °C; inductive load; Fig. 13; Fig. 14		-	0.025	0.1	μs
		I_C = 5 A; I_{Bon} = 1 A; I_{Boff} = -1 A; R_L = 75 Ω ; resistive load; Fig. 11; Fig. 12		-	0.3	0.5	μs

^[1] Measured with half-sine wave voltage (curve tracer).

NPN power transistor with integrated diode

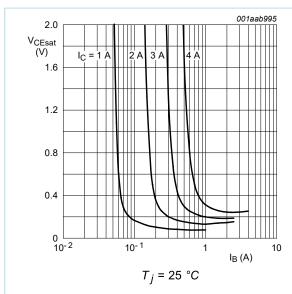


Fig. 6. Collector-emitter saturation voltage as a function of base current; typical values

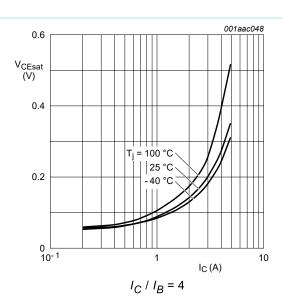


Fig. 7. Collector-emitter saturation voltage as a function of collector current; typical values

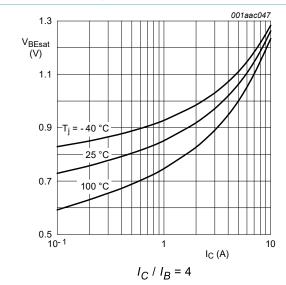


Fig. 8. Base-emitter saturation voltage as a function of collector current; typical values

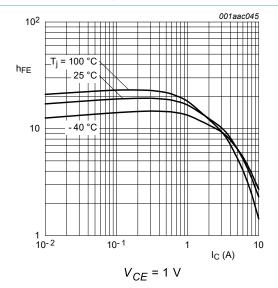


Fig. 9. DC current gain as a function of collector current; typical values

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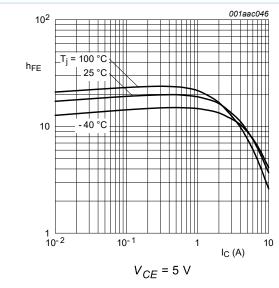


Fig. 10. DC current gain as a function of collector current; typical values

 V_{IM} = -6 to +8 V; V_{CC} = 250 V; t_p = 20 μ s; δ = $\frac{t_p}{T}$ = 0.01 R_B and R_L calculated from I_{Con} and I_{Bon} requirements.

Fig. 11. Test circuit for resistive load switching

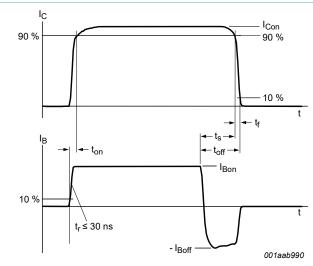
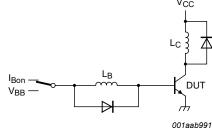


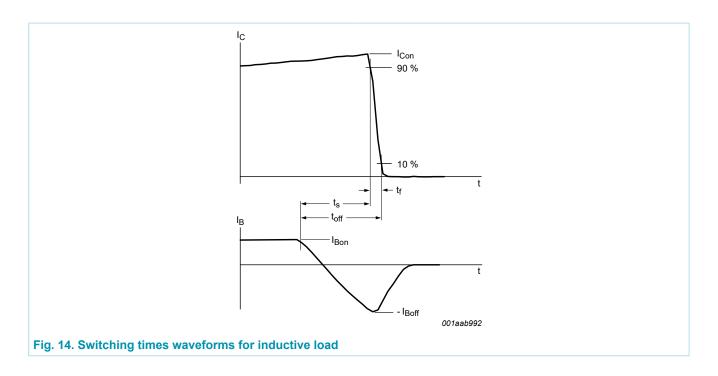
Fig. 12. Switching times waveforms for resistive load



 $V_{CC} = 300 \ V; V_{BB} = -5 \ V; L_C = 200 \ \mu H; L_B = 1 \ \mu H$

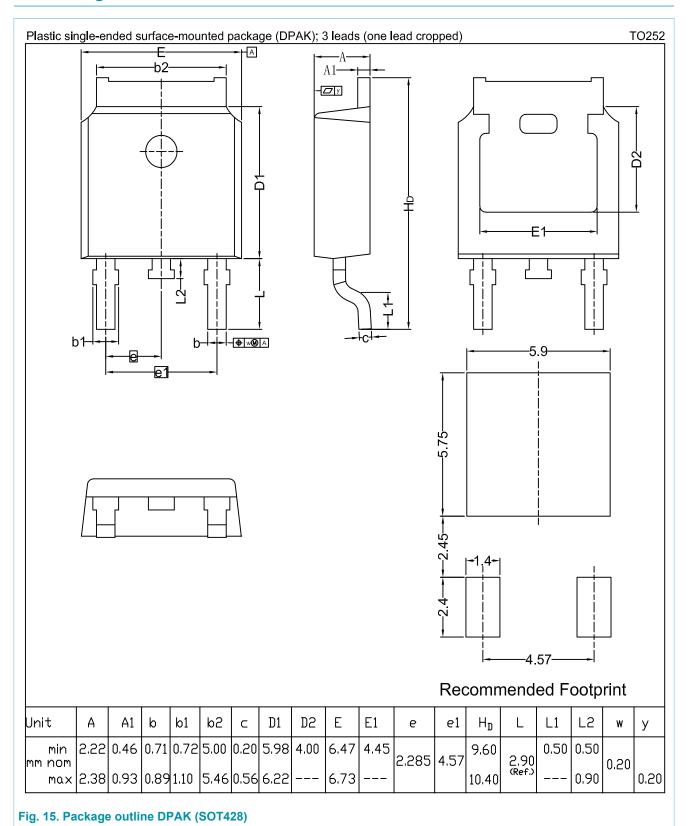
Fig. 13. Test circuit for inductive load switching

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9. Package outline



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10. Legal information

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